

Global Semiconductor Bonding Market Size study, by Process type(Die-to-die bonding, Die-to-wafer bonding, Wafer-to-wafer bonding), by Technology (die bonding, wafer bonding), by type (Die bonder, wafer bonder, flip chip bonder) by Application (Mems and sensors, Cmos image sensors (cis), Radiofrequency (rf) devices, LED), and Regional Forecasts 2021-2027

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Abstracts

Global Semiconductor Bonding Market is valued approximately at USD 848.16 Million in 2020 and is anticipated to grow with a healthy growth rate of more than 3.8% over the forecast period 2021-2027. The global Semiconductor Bonding market is being driven by growing adoption of stacked die technology in IoT devices and rising demand for electric and hybrid vehicles in various regions. Furthermore, increasing demand for 3D semiconductor assembly and packaging as well as growing adoption of IoT and AI in automotive sector will provide new opportunities for the global Semiconductor Bonding industry. For instance, according to statista, there has been significant rise in the production of hybrid electric vehicles; in year 2020, the production stood at 2.9 million units worldwide, and it is expected to grow to 5.4 million units by year 2025. As a result, increased production of hybrid electric vehicles will necessitate the use of semiconductor bonding and will serve as a catalyst for the Semiconductor Bonding industry in the future. However, high cost of ownership may impede market growth over the forecast period of 2021-2027.

Asia Pacific, North America, Europe, Latin America, and Rest of the World are the key region considered for the regional analysis of global Semiconductor Bonding Market. The increasing number of IDMs in the region makes Asia Pacific a significant region across the world in terms of market share. Whereas Asia pacific is also anticipated to



exhibit the highest CAGR over the forecast period 2021-2027, due to the mass production of electronic products such as smartphones, wearables, and white goods in China and Taiwan in the region.

Major market player included in this report are:

Asm pacific technology

BESI

Panasonic

Fasford technology

Shinkawa LTD

EV group (EVG)

Suss microtec SE

Kulicke & soffa industries

Palomar technologies

Shibaura mechatronics

The objective of the study is to define market sizes of different segments & countries in recent years and to forecast the values to the coming eight years. The report is designed to incorporate both qualitative and quantitative aspects of the industry within each of the regions and countries involved in the study. Furthermore, the report also caters the detailed information about the crucial aspects such as driving factors & challenges which will define the future growth of the market. Additionally, the report shall also incorporate available opportunities in micro markets for stakeholders to invest along with the detailed analysis of competitive landscape and product offerings of key players. The detailed segments and sub-segment of the market are explained below:

By Process Type:

Die-to-die bonding

Die-to-wafer bonding

Wafer-to-wafer bonding

By Technology:

Die bonding

wafer bonding

By type:

Die bonder

Wafer bonder

Flip chip Bonder

By Application:



Mems and sensors Cmos image sensors (cis) Radiofrequency (rf) devices LED

By Region:

North America

U.S.

Canada

Europe

UK

Germany

France

Spain

Italy

ROE

Asia Pacific

China

India

Japan

Australia

South Korea

RoAPAC

Latin America

Brazil

Mexico

Rest of the World

Furthermore, years considered for the study are as follows:

Historical year – 2018, 2019

Base year - 2020

Forecast period – 2021 to 2027.

Target Audience of the Global Semiconductor Bonding Market in Market Study:

Key Consulting Companies & Advisors

Global Semiconductor Bonding Market Size study, by Process type(Die-to-die bonding, Die-to-wafer bonding, Wafe...



Large, medium-sized, and small enterprises
Venture capitalists
Value-Added Resellers (VARs)
Third-party knowledge providers
Investment bankers
Investors



Contents

CHAPTER 1. EXECUTIVE SUMMARY

- 1.1. Market Snapshot
- 1.2. Global & Segmental Market Estimates & Forecasts, 2019-2027 (USD Million)
 - 1.2.1. Semiconductor Bonding Market, by region, 2019-2027 (USD Million)
- 1.2.2. Semiconductor Bonding Market, by Process Type, 2019-2027 (USD Million)
- 1.2.3. Semiconductor Bonding Market, by Technology, 2019-2027 (USD Million)
- 1.2.4. Semiconductor Bonding Market, by Type, 2019-2027 (USD Million)
- 1.2.5. Semiconductor Bonding Market, by Application, 2019-2027 (USD Million)
- 1.3. Key Trends
- 1.4. Estimation Methodology
- 1.5. Research Assumption

CHAPTER 2. GLOBAL SEMICONDUCTOR BONDING MARKET DEFINITION AND SCOPE

- 2.1. Objective of the Study
- 2.2. Market Definition & Scope
 - 2.2.1. Scope of the Study
 - 2.2.2. Industry Evolution
- 2.3. Years Considered for the Study
- 2.4. Currency Conversion Rates

CHAPTER 3. GLOBAL SEMICONDUCTOR BONDING MARKET DYNAMICS

- 3.1. Semiconductor Bonding Market Impact Analysis (2019-2027)
 - 3.1.1. Market Drivers
 - 3.1.1.1. Increasing adoption of stacked die technology in IoT devices
 - 3.1.1.2. Rising demand for electric and hybrid vehicles
 - 3.1.2. Market Restraint
 - 3.1.2.1. High cost of ownership
 - 3.1.3. Market Opportunities
 - 3.1.3.1. Increasing demand for 3D semiconductor assembly and packaging
 - 3.1.3.2. Growing adoption of IoT and AI in automotive sector

CHAPTER 4. GLOBAL SEMICONDUCTOR BONDING MARKET INDUSTRY ANALYSIS



- 4.1. Porter's 5 Force Model
 - 4.1.1. Bargaining Power of Suppliers
 - 4.1.2. Bargaining Power of Buyers
 - 4.1.3. Threat of New Entrants
 - 4.1.4. Threat of Substitutes
 - 4.1.5. Competitive Rivalry
 - 4.1.6. Futuristic Approach to Porter's 5 Force Model (2018-2027)
- 4.2. PEST Analysis
 - 4.2.1. Political
- 4.2.2. Economical
- 4.2.3. Social
- 4.2.4. Technological
- 4.3. Investment Adoption Model
- 4.4. Analyst Recommendation & Conclusion

CHAPTER 5. GLOBAL SEMICONDUCTOR BONDING MARKET, BY PROCESS TYPE

- 5.1. Market Snapshot
- 5.2. Global Semiconductor Bonding Market by Process Type, Performance Potential Analysis
- 5.3. Global Semiconductor Bonding Market Estimates & Forecasts by Process Type 2018-2027 (USD Million)
- 5.4. Semiconductor Bonding Market, Sub Segment Analysis
 - 5.4.1. Die-to-die bonding
 - 5.4.2. Die-to-wafer bonding
 - 5.4.3. Wafer-to-wafer bonding

CHAPTER 6. GLOBAL SEMICONDUCTOR BONDING MARKET, BY TECHNOLOGY

- a. Market Snapshot
- 6.1. Global Semiconductor Bonding Market by Technology, Performance Potential Analysis
- 6.2. Global Semiconductor Bonding Market Estimates & Forecasts by Technology 2018-2027 (USD Million)
- 6.3. Semiconductor Bonding Market, Sub Segment Analysis
 - 6.3.1. Die bonding
 - 6.3.2. Wafer bonding



CHAPTER 7. GLOBAL SEMICONDUCTOR BONDING MARKET, BY TYPE

- b. Market Snapshot
- 7.1. Global Semiconductor Bonding Market by Type, Performance Potential Analysis
- 7.2. Global Semiconductor Bonding Market Estimates & Forecasts by Type 2018-2027 (USD Million)
- 7.3. Semiconductor Bonding Market, Sub Segment Analysis
 - 7.3.1. Die bonder
 - 7.3.2. Wafer bonder
 - 7.3.3. Flip chip Bonder

CHAPTER 8. GLOBAL SEMICONDUCTOR BONDING MARKET, BY APPLICATION

- c. Market Snapshot
- 8.1. Global Semiconductor Bonding Market by Application, Performance Potential Analysis
- 8.2. Global Semiconductor Bonding Market Estimates & Forecasts by Application 2018-2027 (USD Million)
- 8.3. Semiconductor Bonding Market, Sub Segment Analysis
 - 8.3.1. Mems and sensors
 - 8.3.2. Cmos image sensors (cis)
 - 8.3.3. Radiofrequency (rf) devices
 - 8.3.4. LED
 - 8.3.5. 3D Nand

CHAPTER 9. GLOBAL SEMICONDUCTOR BONDING MARKET, REGIONAL ANALYSIS

- 9.1. Semiconductor Bonding Market, Regional Market Snapshot
- 9.2. North America Semiconductor Bonding Market
 - 9.2.1. U.S. Semiconductor Bonding Market
 - 9.2.1.1. Process Type breakdown estimates & forecasts, 2018-2027
 - 9.2.1.2. Technology breakdown estimates & forecasts, 2018-2027
 - 9.2.1.3. Type breakdown estimated & forecasts, 2018-2027
 - 9.2.1.4. Application breakdown estimates & forecasts, 2018-2027
 - 9.2.2. Canada Semiconductor Bonding Market
- 9.3. Europe Semiconductor Bonding Market Snapshot
 - 9.3.1. U.K. Semiconductor Bonding Market



- 9.3.2. Germany Semiconductor Bonding Market
- 9.3.3. France Semiconductor Bonding Market
- 9.3.4. Spain Semiconductor Bonding Market
- 9.3.5. Italy Semiconductor Bonding Market
- 9.3.6. Rest of Europe Semiconductor Bonding Market
- 9.4. Asia-Pacific Semiconductor Bonding Market Snapshot
 - 9.4.1. China Semiconductor Bonding Market
 - 9.4.2. India Semiconductor Bonding Market
 - 9.4.3. Japan Semiconductor Bonding Market
 - 9.4.4. Australia Semiconductor Bonding Market
 - 9.4.5. South Korea Semiconductor Bonding Market
 - 9.4.6. Rest of Asia Pacific Semiconductor Bonding Market
- 9.5. Latin America Semiconductor Bonding Market Snapshot
 - 9.5.1. Brazil Semiconductor Bonding Market
 - 9.5.2. Mexico Semiconductor Bonding Market
- 9.6. Rest of The World Semiconductor Bonding Market

CHAPTER 10. COMPETITIVE INTELLIGENCE

- 10.1. Top Market Strategies
- 10.2. Company Profiles
 - 10.2.1. Asm pacific technology
 - 10.2.1.1. Key Information
 - 10.2.1.2. Overview
 - 10.2.1.3. Financial (Subject to Data Availability)
 - 10.2.1.4. Product Summary
 - 10.2.1.5. Recent Developments
 - 10.2.2. BESI
 - 10.2.3. Panasonic
 - 10.2.4. Fasford technology
 - 10.2.5. Shinkawa LTD
 - 10.2.6. EV group (EVG)
 - 10.2.7. Suss microtec SE
 - 10.2.8. Kulicke & soffa industries
 - 10.2.9. Palomar technologies
 - 10.2.10. Shibaura mechatronics

CHAPTER 11. RESEARCH PROCESS



- 11.1. Research Process
 - 11.1.1. Data Mining
 - 11.1.2. Analysis
 - 11.1.3. Market Estimation
 - 11.1.4. Validation
 - 11.1.5. Publishing
- 11.2. Research Attributes
- 11.3. Research Assumption



List Of Tables

LIST OF TABLES

TABLE 2. Global Semiconductor Bonding Market, report scope

TABLE 3. Global Semiconductor Bonding Market estimates & forecasts by region 2018-2027 (USD Million)

TABLE 4. Global Semiconductor Bonding Market estimates & forecasts by Process Type 2018-2027 (USD Million)

TABLE 5. Global Semiconductor Bonding Market estimates & forecasts by Technology 2018-2027 (USD Million)

TABLE 6. Global Semiconductor Bonding Market estimated & forecasts by Type, 2018-2027 (USD Million)

TABLE 7.

TABLE 8. Global Semiconductor Bonding Market estimates & forecasts by Application 2018-2027 (USD Million)

TABLE 9. Global Semiconductor Bonding Market by segment, estimates & forecasts, 2018-2027 (USD Million)

TABLE 10. Global Semiconductor Bonding Market by region, estimates & forecasts, 2018-2027 (USD Million)

TABLE 11. Global Semiconductor Bonding Market by segment, estimates & forecasts, 2018-2027 (USD Million)

TABLE 12. Global Semiconductor Bonding Market by region, estimates & forecasts, 2018-2027 (USD Million)

TABLE 13. Global Semiconductor Bonding Market by segment, estimates & forecasts, 2018-2027 (USD Million)

TABLE 14. Global Semiconductor Bonding Market by region, estimates & forecasts, 2018-2027 (USD Million)

TABLE 15. Global Semiconductor Bonding Market by segment, estimates & forecasts, 2018-2027 (USD Million)

TABLE 16. Global Semiconductor Bonding Market by region, estimates & forecasts, 2018-2027 (USD Million)

TABLE 17. Global Semiconductor Bonding Market by segment, estimates & forecasts, 2018-2027 (USD Million)

TABLE 18. Global Semiconductor Bonding Market by region, estimates & forecasts, 2018-2027 (USD Million)

TABLE 19. Global Semiconductor Bonding Market by segment, estimates & forecasts, 2018-2027 (USD Million)

TABLE 20. Global Semiconductor Bonding Market by region, estimates & forecasts,



- 2018-2027 (USD Million)
- TABLE 21. Global Semiconductor Bonding Market by segment, estimates & forecasts, 2018-2027 (USD Million)
- TABLE 22. Global Semiconductor Bonding Market by region, estimates & forecasts, 2018-2027 (USD Million)
- TABLE 23. Global Semiconductor Bonding Market by segment, estimates & forecasts, 2018-2027 (USD Million)
- TABLE 24. Global Semiconductor Bonding Market by region, estimates & forecasts, 2018-2027 (USD Million)
- TABLE 25. U.S. Semiconductor Bonding Market estimates & forecasts, 2018-2027 (USD Million)
- TABLE 26. U.S. Semiconductor Bonding Market estimates & forecasts by segment 2018-2027 (USD Million)
- TABLE 27. U.S. Semiconductor Bonding Market estimates & forecasts by segment 2018-2027 (USD Million)
- TABLE 28. Canada Semiconductor Bonding Market estimates & forecasts, 2018-2027 (USD Million)
- TABLE 29. Canada Semiconductor Bonding Market estimates & forecasts by segment 2018-2027 (USD Million)
- TABLE 30. Canada Semiconductor Bonding Market estimates & forecasts by segment 2018-2027 (USD Million)
- TABLE 31. UK Semiconductor Bonding Market estimates & forecasts, 2018-2027 (USD Million)
- TABLE 32. UK Semiconductor Bonding Market estimates & forecasts by segment 2018-2027 (USD Million)
- TABLE 33. UK Semiconductor Bonding Market estimates & forecasts by segment 2018-2027 (USD Million)
- TABLE 34. Germany Semiconductor Bonding Market estimates & forecasts, 2018-2027 (USD Million)
- TABLE 35. Germany Semiconductor Bonding Market estimates & forecasts by segment 2018-2027 (USD Million)
- TABLE 36. Germany Semiconductor Bonding Market estimates & forecasts by segment 2018-2027 (USD Million)
- TABLE 37. France Semiconductor Bonding Market estimates & forecasts, 2018-2027 (USD Million)
- TABLE 38. France Semiconductor Bonding Market estimates & forecasts by segment 2018-2027 (USD Million)
- TABLE 39. France Semiconductor Bonding Market estimates & forecasts by segment 2018-2027 (USD Million)



- TABLE 40. Spain Semiconductor Bonding Market estimates & forecasts, 2018-2027 (USD Million)
- TABLE 41. Spain Semiconductor Bonding Market estimates & forecasts by segment 2018-2027 (USD Million)
- TABLE 42. Spain Semiconductor Bonding Market estimates & forecasts by segment 2018-2027 (USD Million)
- TABLE 43. Italy Semiconductor Bonding Market estimates & forecasts, 2018-2027 (USD Million)
- TABLE 44. Italy Semiconductor Bonding Market estimates & forecasts by segment 2018-2027 (USD Million)
- TABLE 45. Italy Semiconductor Bonding Market estimates & forecasts by segment 2018-2027 (USD Million)
- TABLE 46. ROE Semiconductor Bonding Market estimates & forecasts, 2018-2027 (USD Million)
- TABLE 47. ROE Semiconductor Bonding Market estimates & forecasts by segment 2018-2027 (USD Million)
- TABLE 48. ROE Semiconductor Bonding Market estimates & forecasts by segment 2018-2027 (USD Million)
- TABLE 49. China Semiconductor Bonding Market estimates & forecasts, 2018-2027 (USD Million)
- TABLE 50. China Semiconductor Bonding Market estimates & forecasts by segment 2018-2027 (USD Million)
- TABLE 51. China Semiconductor Bonding Market estimates & forecasts by segment 2018-2027 (USD Million)
- TABLE 52. India Semiconductor Bonding Market estimates & forecasts, 2018-2027 (USD Million)
- TABLE 53. India Semiconductor Bonding Market estimates & forecasts by segment 2018-2027 (USD Million)
- TABLE 54. India Semiconductor Bonding Market estimates & forecasts by segment 2018-2027 (USD Million)
- TABLE 55. Japan Semiconductor Bonding Market estimates & forecasts, 2018-2027 (USD Million)
- TABLE 56. Japan Semiconductor Bonding Market estimates & forecasts by segment 2018-2027 (USD Million)
- TABLE 57. Japan Semiconductor Bonding Market estimates & forecasts by segment 2018-2027 (USD Million)
- TABLE 58. Australia Semiconductor Bonding Market estimates & forecasts, 2018-2027 (USD Million)
- TABLE 59. Australia Semiconductor Bonding Market estimates & forecasts by segment



2018-2027 (USD Million)

TABLE 60. Australia Semiconductor Bonding Market estimates & forecasts by segment 2018-2027 (USD Million)

TABLE 61. South Korea Semiconductor Bonding Market estimates & forecasts, 2018-2027 (USD Million)

TABLE 62. South Korea Semiconductor Bonding Market estimates & forecasts by segment 2018-2027 (USD Million)

TABLE 63. South Korea Semiconductor Bonding Market estimates & forecasts by segment 2018-2027 (USD Million)

TABLE 64. ROPAC Semiconductor Bonding Market estimates & forecasts, 2018-2027 (USD Million)

TABLE 65. ROPAC Semiconductor Bonding Market estimates & forecasts by segment 2018-2027 (USD Million)

TABLE 66. ROPAC Semiconductor Bonding Market estimates & forecasts by segment 2018-2027 (USD Million)

TABLE 67. Brazil Semiconductor Bonding Market estimates & forecasts, 2018-2027 (USD Million)

TABLE 68. Brazil Semiconductor Bonding Market estimates & forecasts by segment 2018-2027 (USD Million)

TABLE 69. Brazil Semiconductor Bonding Market estimates & forecasts by segment 2018-2027 (USD Million)

TABLE 70. Mexico Semiconductor Bonding Market estimates & forecasts, 2018-2027 (USD Million)

TABLE 71. Mexico Semiconductor Bonding Market estimates & forecasts by segment 2018-2027 (USD Million)

TABLE 72. Mexico Semiconductor Bonding Market estimates & forecasts by segment 2018-2027 (USD Million)

TABLE 73. ROLA Semiconductor Bonding Market estimates & forecasts, 2018-2027 (USD Million)

TABLE 74. ROLA Semiconductor Bonding Market estimates & forecasts by segment 2018-2027 (USD Million)

TABLE 75. ROLA Semiconductor Bonding Market estimates & forecasts by segment 2018-2027 (USD Million)

TABLE 76. ROW Semiconductor Bonding Market estimates & forecasts, 2018-2027 (USD Million)

TABLE 77. ROW Semiconductor Bonding Market estimates & forecasts by segment 2018-2027 (USD Million)

TABLE 78. ROW Semiconductor Bonding Market estimates & forecasts by segment 2018-2027 (USD Million)



TABLE 79. List of secondary sources used in the study of global Semiconductor Bonding Market.

TABLE 80. List of primary sources used in the study of global Semiconductor Bonding Market.

TABLE 81. Years considered for the study.

TABLE 82. Exchange rates considered.



List Of Figures

LIST OF FIGURES

- FIG 1. Global Semiconductor Bonding Market, research methodology
- FIG 2. Global Semiconductor Bonding Market, market estimation techniques
- FIG 3. Global market size estimates & forecast methods
- FIG 4. Global Semiconductor Bonding Market, key trends 2020
- FIG 5. Global Semiconductor Bonding Market, growth prospects 2021-2027
- FIG 6. Global Semiconductor Bonding Market, porters 5 force model
- FIG 7. Global Semiconductor Bonding Market, pest analysis
- FIG 8. Global Semiconductor Bonding Market, value chain analysis
- FIG 9. Global Semiconductor Bonding Market by segment, 2018 & 2027 (USD Million)
- FIG 10. Global Semiconductor Bonding Market by segment, 2018 & 2027 (USD Million)
- FIG 11. Global Semiconductor Bonding Market by segment, 2018 & 2027 (USD Million)
- FIG 12. Global Semiconductor Bonding Market by segment, 2018 & 2027 (USD Million)
- FIG 13. Global Semiconductor Bonding Market by segment, 2018 & 2027 (USD Million)
- FIG 14. Global Semiconductor Bonding Market by segment, 2018 & 2027 (USD Million)
- FIG 15. Global Semiconductor Bonding Market by segment, 2018 & 2027 (USD Million)
- FIG 16. Global Semiconductor Bonding Market by segment, 2018 & 2027 (USD Million)
- FIG 17. Global Semiconductor Bonding Market, regional snapshot 2018 & 2027
- FIG 18. North America Semiconductor Bonding Market 2018 & 2027 (USD Million)
- FIG 19. Europe Semiconductor Bonding Market 2018 & 2027 (USD Million)
- FIG 20. Asia-Pacific Semiconductor Bonding Market 2018 & 2027 (USD Million)
- FIG 21. Latin America Semiconductor Bonding Market 2018 & 2027 (USD Million)
- FIG 22. Global Semiconductor Bonding Market, company market share analysis (2020)



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